

**DLC Display Co., Limited**

德爾西顯示器有限公司



MODEL No: DLC0154AZS-T

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### Record of Revision

Date	Revision No.	Summary
2016-04-06	1.0	Rev 1.0 was issued
2016-04-19	1.1	Update the Luminance, FPC of LCM do not bend

### 1. Scope

This data sheet is to introduce the specification of DLC0154AZS-T active matrix TFT module. It is composed of a color TFT-LCD panel, driver ICs, FPC, capacitive touch panel and a backlight unit. The 1.54' display area contains 240(RGB) x 240 pixels.

As to basic specification of the driver IC, refer to the IC (GC9304) specification and datasheet.

### 2. Application

Digital equipments which need color display, mobile phone, mobile navigator/video systems.

### 3. General Information

Item	Contents	Unit
Size	1.54	inch
Resolution	240(RGB) x 240	
Interface	SPI	
Technology type	IPS	
Pixel pitch	/	mm
Pixel Configuration	R.G.B. Vertical Stripe	
Outline Dimension (W x H x D)	35.75x 39.45 x2.70	mm
Active Area	27.72 x 27.72	mm
Display Mode	Transmissive	
Backlight Type	LED	
Driver IC	GC9304	
Driver IC of CTP	FT6236	
Weight	TBD	g

### 4. Outline Drawing

**FPC INTERFACE (LCM)**

PIN	NAME
1	LEDK
2	LEDK
3	GND
4	GND
5	FMARK
6	SDA
7	LSAO
8	SCL
9	CS
10	RESET
11	IOVCC18
12	IOVCC18
13	VCC28
14	VCC28
15	GND
16	GND
17	NC
18	NC
19	NC
20	NC
21	NC
22	NC
23	LEDA
24	LEDA

**FPC INTERFACE (CTP)**

PIN	DEFINE
1	VDD-28V
2	SCL
3	SDA
4	EINT
5	RESET
6	GND
7	GND
8	NC
9	GND
10	GND

**NOTE:**

- 1 DISPLAY TYPE : 1.54" TFT LCM+CTP
- 2 VIEWING DIRECTION : ALL
- 3 LCD DRIVER : GC9304
- 4 CTP DRIVER : FT6236
- 5 OPERATING TEMP : -20° C---+70° C
- 6 STORAGE TEMP : -30° C---+80° C
- 7 UNSPECIFIED TOLERANCE ±0.2
- 8 RoHS compllicant

**LED SYMBOL:** Vf=2.9~3.5V, If=60mA

**COMPANY:** DLC Display Co., Limited  
www.dlcdisplay.com

DRAWN BY:	CHECKED BY:	APPROVED BY:	CONFIRMED BY:
TITLE: DLC0154AZS-T			
DWG NO:			
DWG NAME:			
SCALE:			UNIT: mm
SHEET NO:			OF

5. Interface signals

NO.	I/O	SYMBOL	DISCRIPTION
1	P	LEDK	Cathode pin of backlight.
2	P	LEDK	Cathode pin of backlight.
3	P	GND	Ground
4	P	GND	Ground
5	-	FMARK	Tearing effect output.
6	I/O	SDA	Data Input
7	I	LSA0	Data Or Command Selection
8	I	SCL	Synchronous Clock
9	I	CS	Chip select input pin ( “Low” enable).
10	I	RESET	This signal will reset the device and must be applied to properly initialize the chip. Signal is active low.
11	P	IOVCC18	Power voltage for logic(1.8V).
12	P	IOVCC18	Power voltage for logic(1.8V).
13	P	VCC28	Supply voltage(2.8V).
14	P	VCC28	Supply voltage(2.8V).
15	P	GND	Ground.
16	P	GND	Ground.
17-22		NC	NC
23	P	LEDA	Anode pin of backlight.
24	P	LEDA	Anode pin of backlight.

The connector number: DF37B-24DP-0.4V

CTP:

PIN	Symbol	Description	Remark
1	VDD	Power supply	
2	SCL	I2C clock signal.	
3	SDA	I2C data signal	
4	EINT	Interrupt output Pin	
5	RESET	Reset pin	
6	GND	Ground	
7	GND	Ground	
8	NC	NC	
9	GND	Ground	
10	GND	Ground	

The connector number: OK-20M010-04

## 6. Absolute maximum Ratings

### 6.1. Electrical Absolute max. ratings

GND=0V, Ta=25°C

Parameter	Symbol	MIN	MAX	Unit	Remark
Supply voltage	VCC	-0.3	+4.6	V	
Power voltage for logic	IOVCC	-0.3	+4.6	V	
Logic input voltage range	VIN	-0.3	IOVCC+0.3	V	
Logic output voltage range	VOOUT	-0.3	IOVCC+0.3	V	

### 6.2. Environment Condition

Item	Symbol	MIN	MAX	Unit	Remark
Operating Temperature	TOPR	-20	70	°C	
Storage Temperature	TSTG	-30	80	°C	

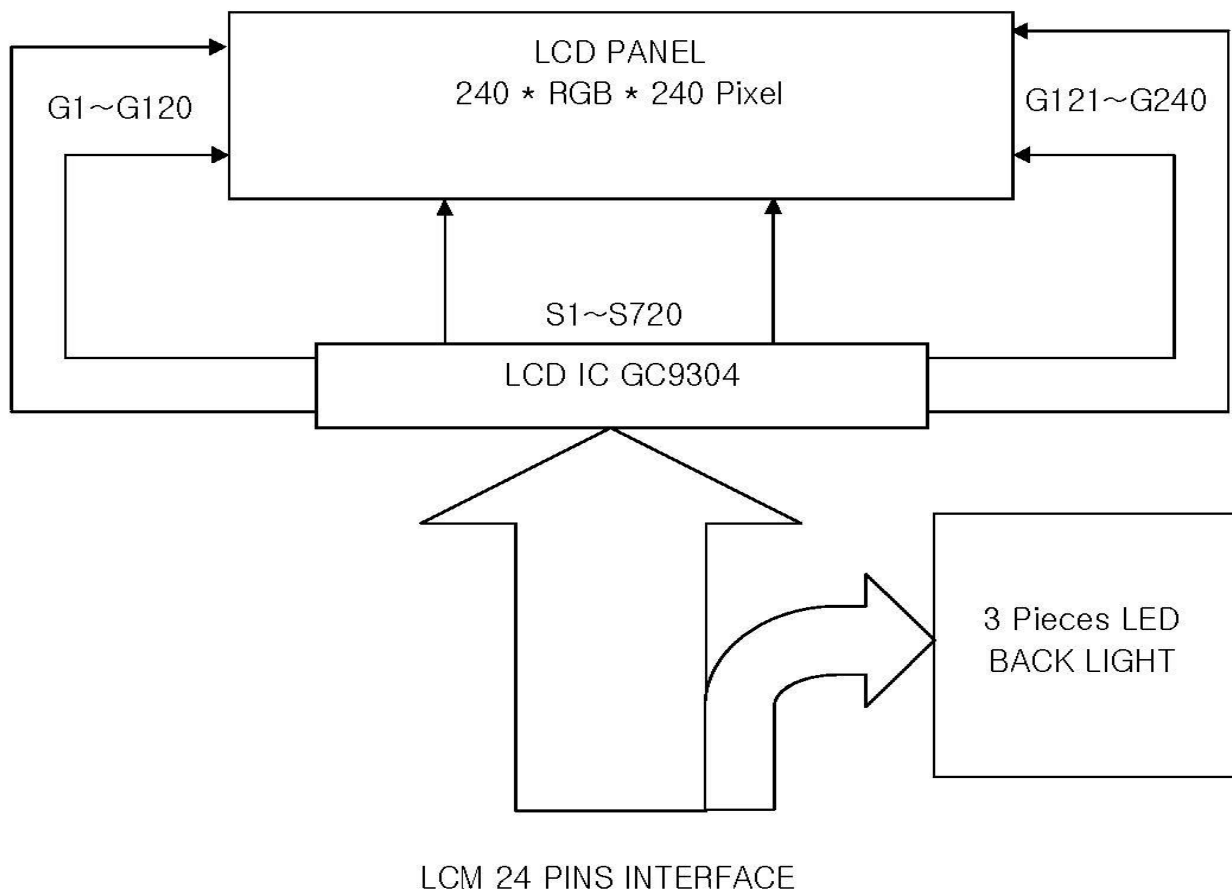
## 7. Electrical Specifications

### 7.1 Electrical characteristics

Ta=25°C

Parameter	Symbol	MIN	Typ	MAX	Unit	Remark
Supply voltage	VCC	2.5	2.8	3.3		
Power voltage for logic	IOVCC	1.65	1.8	3.3	V	
Supply current for LCM	ILCD	--	8	--	mA	VCC = 2.8V
Supply voltage for back light	VLED	2.9	3.2	3.5	V	
Supply current for back light	ILED	--	60	--	mA	VL = 6.6V
Lifetime of LED	--	--	25,000	--	Hr	

### 7.2 BLOCK DIAGRAM



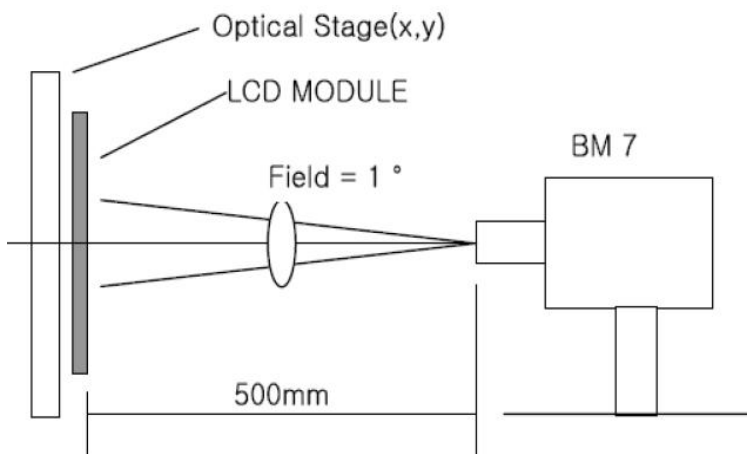
## 8. Optical Specification

Ta=25°C

Item	Symbol	Condition	Min	Typ.	Max.	Unit	Remark
Contrast Ratio	CR	$\theta=0^\circ$	--	650	--		Note1 Note2
Response Time	Tr/ Tf	25°C	--	--	--	ms	Note1 Note3
View Angles	$\theta T$	$CR \geq 10$	--	80	--	Degree	Note 4
	$\theta B$		--	80	--		
	$\theta L$		--	80	--		
	$\theta R$		--	80	--		
Chromaticity	White	x	Brightness is on	0.246	0.276	0.306	Note5, Note1
		y		0.285	0.315	0.345	
NTSC	S		--	--	--	%	Note5
Luminance	L		350	430	--	cd/m <sup>2</sup>	Note1 Note6
Uniformity	U		--	80	--	%	Note1 Note7

Note 1: Definition of optical measurement system.

Temperature = 25°C(±3°C); LED back-light: ON, Environment brightness < 150 lx



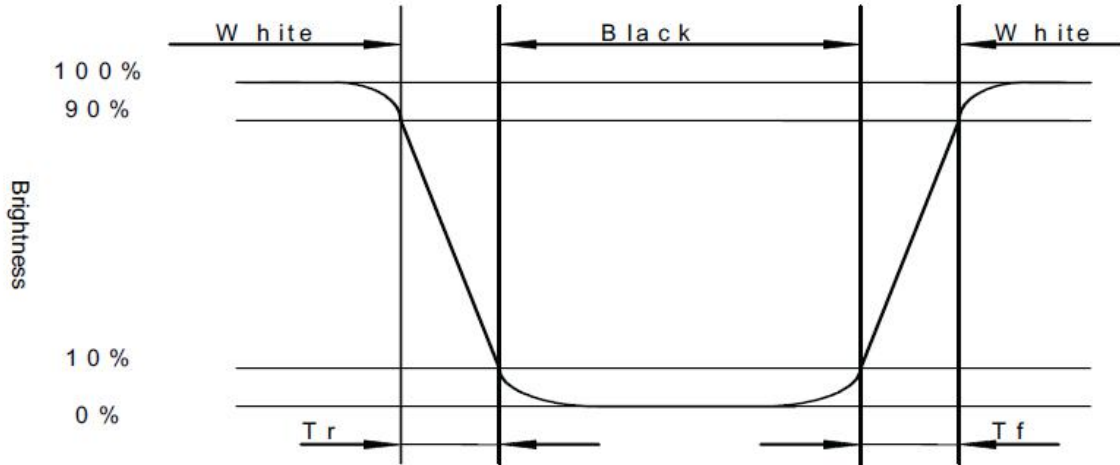
Note 2: Contrast ratio is defined as follow:

$$\text{Contrast Ratio} = \frac{\text{Surface Luminance with all white pixels}}{\text{Surface Luminance with all black pixels}}$$



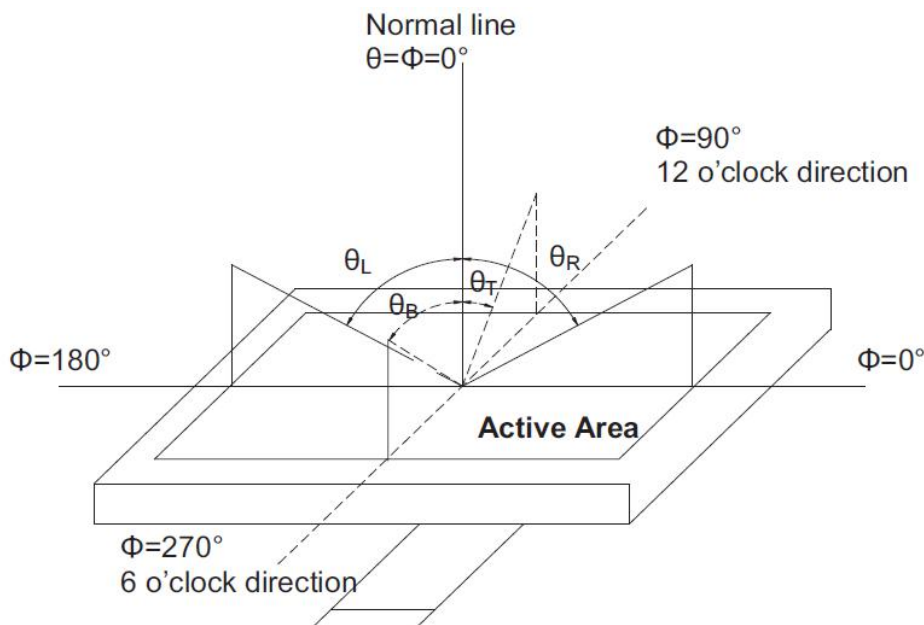
Note 3: Response time is defined as follow:

Response time is the time required for the display to transition from black to white (Rise Time,  $T_r$ ) and from white to black(Decay Time,  $T_f$ ).



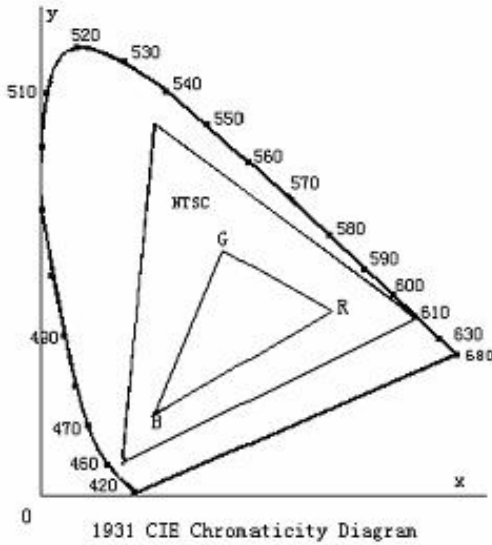
Note 4: Viewing angle range is defined as follow:

Viewing angle is measured at the center point of the LCD.



Note 5: Color chromaticity is defined as follow: (CIE1931)

Color coordinates measured at center point of LCD.



$$S = \frac{\text{area of RGB triangle}}{\text{area of NTSC triangle}} \times 100\%$$

Note 6: Luminance is defined as follow:

Luminance is defined as the brightness of all pixels “White” at the center of display area on optimum contrast.

Note 7: Luminance Uniformity is defined as follow:

Active area is divided into 9 measuring areas (Refer Fig. 2). Every measuring point is placed at the center of each measuring area.

$$\text{Uniformity (U)} = \frac{\text{Minimum Luminance( brightness ) in 9 points}}{\text{Maximum Luminance( brightness ) in 9 points}}$$

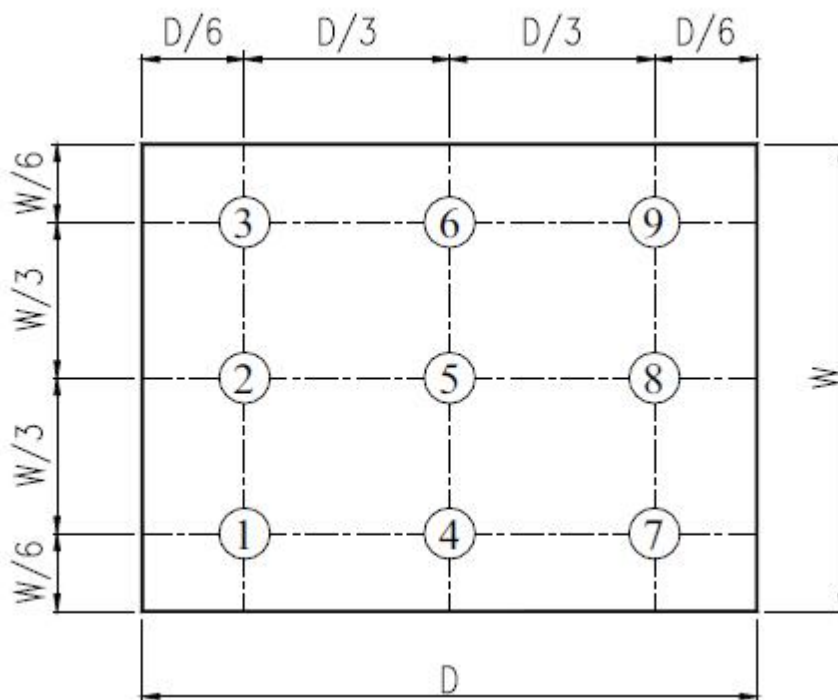


Fig. 2 Definition of uniformity

9. Environmental / Reliability Tests

No	Test Item	Condition	Judgment criteria
1	High Temp Operation	Ts=+70°C, 120hrs	Per table in below
2	Low Temp Operation	Ta=-20°C, 120hrs	Per table in below
3	High Temp Storage	Ta=+80°C, 120hrs	Per table in below
4	Low Temp Storage	Ta=-30°C, 120hrs	Per table in below
5	High Temp & High Humidity Storage	Ta=+40°C, 90% RH 120 hours	Per table in below (polarizer discoloration is excluded)
6	Thermal Shock (Non-operation)	-30°C 30 min~+80°C 30 min, Change time:5min, 10 Cycles	Per table in below
7	ESD (Operation)	C=150pF, R=330Ω, 5points/panel Air:±8KV, 5times; Contact:±4KV, 5 times;	Per table in below
8	Vibration (Non-operation)	Frequency range:10~55Hz, Stroke:1.5mm Sweep:10Hz~55Hz~10Hz 2 hours for each direction of X.Y.Z.	Per table in below
9	Shock (Non-operation)	60G 6ms, ±X,±Y,±Z 3times, for each direction	Per table in below
10	Package Drop Test	Height:80 cm, 1 corner, 3 edges, 6 surfaces	Per table in below

INSPECTION	CRITERION(after test)
Appearance	No Crack on the FPC, on the LCD Panel
Alignment of LCD Panel	No Bubbles in the LCD Panel No other Defects of Alignment in Active area
Electrical current	Within device specifications
Function / Display	No Broken Circuit, No Short Circuit or No Black line No Other Defects of Display

## 10. Precautions for Use of LCD Modules

### 10.1 Safety

The liquid crystal in the LCD is poisonous. Do not put it in your mouth. If the liquid crystal touches your skin or clothes, wash it off immediately using soap and water.

### 10.2 Handling

- A. The LCD and touch panel is made of plate glass. Do not subject the panel to mechanical shock or to excessive force on its surface.
- B. Do not handle the product by holding the flexible pattern portion in order to assure the reliability
- C. Transparency is an important factor for the touch panel. Please wear clear finger sacks, gloves and mask to protect the touch panel from finger print or stain and also hold the portion outside the view area when handling the touch panel.
- D. Provide a space so that the panel does not come into contact with other components.
- E. To protect the product from external force, put a covering lens (acrylic board or similar board) and keep an appropriate gap between them.
- F. Transparent electrodes may be disconnected if the panel is used under environmental conditions where dew condensation occurs.
- G. Property of semiconductor devices may be affected when they are exposed to light, possibly resulting in IC malfunctions.
- H. To prevent such IC malfunctions, your design and mounting layout shall be done in the way that the IC is not exposed to light in actual use.

### 10.3 Static Electricity

- A. Ground soldering iron tips, tools and testers when they are in operation.
- B. Ground your body when handling the products.
- C. Power on the LCD module before applying the voltage to the input terminals.
- D. Do not apply voltage which exceeds the absolute maximum rating.
- E. Store the products in an anti-electrostatic bag or container.

### 10.4 Storage

- A. Store the products in a dark place at  $+25^{\circ}\text{C} \pm 10^{\circ}\text{C}$  with low humidity (40% RH to 60% RH). Don't expose to sunlight or fluorescent light.
- B. Storage in a clean environment, free from dust, active gas, and solvent.

### 10.5 Cleaning

- A. Do not wipe the touch panel with dry cloth, as it may cause scratch.
- B. Wipe off the stain on the product by using soft cloth moistened with ethanol. Do not allow ethanol to get in between the upper film and the bottom glass. It may cause peeling issue or defective operation. Do not use any organic solvent or detergent other than ethanol.

### 10.6 Cautions for installing and assembling

Bezel edge must be positioned in the area between the Active area and View area. The bezel may press the touch screen and cause activation if the edge touches the active area. A gap of approximately 0.5mm is needed between the bezel and the top electrode. It may cause unexpected activation if the gap is too narrow. There is a tolerance of 0.2 to 0.3mm for the outside dimensions of the touch panel and tail. A gap must be made to absorb the tolerance in the case and connector.

